

Crystal oscillator

CRYSTAL OSCILLATOR (Programmable) OUTPUT: CMOS

SG-8201 series

- Frequency range
- Supply voltage
- : 1.2 MHz to 170 MHz : 1.62 V to 3.63 V
 - : Output enable (OE/OE) or Standby (ST/ST)
- Function • Frequency tolerance, operating temperature:

- ±15 × 10⁻⁶ (-40 °C to +105 °C) ±25 × 10⁻⁶ (-40 °C to +125 °C)



Product Number SG-8201CJ: X1G005981xxxx16 SG-8201CG: X1G006191xxxx16

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• PLL technology to enable setting any output frequency

Specifications (c			Specifications		Cond	itions/Remark	<i>(</i>)		
nem	Symbol	1.80 V Typ.	2.50 V Typ.	3.30 V Typ.	Conu	10015/Remain	.5		
Supply voltage	Vcc	1.62 V to 1.98 V	2.25 V to 2.75 V	2.97 V to 3.63 V	_				
Output frequency range	fo		1.2 MHz to 170 MHz						
Storage temperature	T_stg		-55 °C to +150 °C	Storage as single produc	t.				
v .			H: -40 °C to +105 °C	5 51					
Operating temperature	T_use		J: -40 °C to +125 °C						
E () *1		B: ±15 × 10 ⁻⁶			T use = -40 °C to +105 °C				
Frequency tolerance ^{*1}	f_tol	D: ±25 × 10 ⁻⁶							
		5.2 mA Typ. 5.4 mA Typ. 5.6 mA Typ.							
		7.0 mA Max.	7.2 mA Max.	7.5 mA Max.	$-1.2 \text{ MHz} \le f_0 \le 25 \text{ MHz}$		_		
l		5.4 mA Typ.	5.7 mA Typ.	6.1 mA Typ.					
		7.3 mA Max.	7.6 mA Max.	8.1 mA Max.	–25 MHz < f₀ ≤ 50 MHz		No load, Rise/Fall time: Default		
		5.7 mA Typ.	6.3 mA Typ.	7.0 mA Typ.	50 MIL . 6 . 75 MIL				
O		7.7 mA Max.	8.2 mA Max.	9.1 mA Max.	50 MHz < f₀ ≤ 75 MHz				
Current consumption	Icc	6.2 mA Typ.	6.9 mA Typ.	7.9 mA Typ.					
		8.2 mA Max.	9.1 mA Max.	10.4 mA Max.	75 MHz < f₀ ≤ 100 MHz				
		6.9 mA Typ.	7.9 mA Typ.	9.1 mA Typ.					
		9.4 mA Max.	10.7 mA Max.	12.4 mA Max.	$-100 \text{ MHz} < f_0 ≤ 125 \text{ MHz}$		_		
		7.8 mA Typ.	9.2 mA Typ.	11.2 mA Typ.					
		10.4 mA Max.	12.4 mA Max.	15.0 mA Max.	-125 MHz < f ₀ ≤ 170 MHz				
		5.0 mA Typ.	5.0 mA Typ.	5.1 mA Typ.					
Output disable current	I_dis	7.2 mA Max.	7.3 mA Max.	7.4 mA Max.	$OE = GND, \overline{OE} = V_{CC}$				
Chain allow assume int	1 - 4-1	0.3 µA Typ.	0.3 µA Typ.	0.5 µA Typ.					
Standby current	I_std	15.0 μA Max. 15.0 μA Max. 15.0 μA Max.			$\overline{ST} = GND, ST = V_{CC}$				
Symmetry	SYM		45 % to 55 %		50 % Vcc Level, L_CMOS	S ≤ 15 pF			
					Rise/Fall time				
	Vон	90 % V _{CC} Min.			Default 'A' Option*2	Other Options			
Output voltage	Vol				fo > 125 MHz	B: Faster	-2.0 mA	2.0 mA	
(DC characteristics)		10 % V _{CC} Max.			75 MHz < fo ≤ 125 MHz	C: Fast	-1.0 mA	1.0 mA	
					$\frac{50 \text{ MHz} < \text{fo} \le 75 \text{ MHz}}{\text{fo} \le 50 \text{ MHz}}$	D: Slow E: Slower	-0.5 mA -0.2 mA	0.5 mA 0.2 mA	
						E. Slowel	-0.2 IIIA	0.2 MA	
Output load condition	L_CMOS		15 pF Max.						
Input voltage	V _{IH} VIL		70 % V _{CC} Min. 30 % V _{CC} Max.		Pin 1				
	VIL		30 % VCC Max.		Default 'A' Option ^{*2}	Other Options			
		- 2.0 ns Max.			fo > 125 MHz	B: Faster	-		
Rise/Fall time	tr/tf		2.5 ns Max.	75 MHz < fo ≤ 125 MHz	C: Fast	Fast 20 % - 80 % V _{CC,} L_CMOS = 15 pF			
			4.0 ns Max.	$50 \text{ MHz} < 10 \le 125 \text{ MHz}$	D: Slow				
			6.0 ns Max.	$f_0 \le 50 \text{ MHz}$	E: Slower				
Output disable time (OE)	tstp_oe				Measured from the time (rosses 30	% Vcc	
Output disable time (ST)	tstp_st		1 µs Max.		or measured from the time \overline{OE} or ST pin crosses 70 % V _{CC}				
Output enable time (OE)	tsta_oe	100 ns + 2 clock cycle Max.			Measured from the time OE pin crosses 70 % V_{CC} or measured from the time \overline{OE} pin crosses 30 % V_{CC}				
Output enable time (ST)	tsta_st	3 ms Max.			Measured from the time \overline{ST} pin crosses 70 % V_{CC} or measured from the time ST pin crosses 30 % V_{CC}				
Start-up time	t_str	3 ms Max.			Measured from the time V_{CC} reaches its rated minimum value, 1.62 V				
	tрյ	1.2 ps Typ. 1.2 ps Typ.			fo = 25 MHz, Offset frequency: 12 kHz to 5 MHz				
Phase Jitter					fo = 50 MHz, Offset frequency: 12 kHz to 20 MHz				
		1.2 ps Typ.			fo = 75 MHz, Offset frequency: 12 kHz to 20 MHz				
		1.2 ps Typ.			fo = 100 MHz, Offset frequency: 12 kHz to 20 MHz				
		1.1 ps Typ.			fo = 125 MHz, Offset frequency: 12 kHz to 20 MHz				
		1.4 ps Typ.			fo = 150 MHz, Offset frequency: 12 kHz to 20 MHz				
		1.5 ps Typ.			fo = 170 MHz, Offset frequency: 12 kHz to 20 MHz				
Frequency aging	f_age	This is included in frequency tolerance specification.			+25 °C, first year				

*1 Frequency tolerance includes initial frequency tolerance, temperature variation, supply voltage variation, reflow drift, load drift and aging (+25 °C, 1 year). *2 Default 'A' Rise/Fall time and $I_{\text{OH}}/I_{\text{OL}}$ are dependent on programmed frequency.



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P	Pin description						
Pin	Name	I/O type	Function				
	OE	Input	Output Enable	High ^{*1} or Open:	Specified frequency output from OUT pin		
	OL			Low:	OUT pin is low (pull down with 500 k Ω), only output driver is disabled.		
	ŌĒ	Input	Output Enable	Low*2 or Open:	Specified frequency output from OUT pin		
	UE			High:	OUT pin is low (pull down with 500 k Ω), only output driver is disabled.		
1	1	Input	Standby	High ^{*1 *3} :	Specified frequency output from OUT pin		
	ST			Low:	OUT pin is low (pull down with 500 k Ω),		
					Device goes to standby mode. Supply current reduces to the least as I_std.		
		Input	Standby	Low ^{*2 *3} :	Specified frequency output from OUT pin		
	ST			High:	OUT pin is low (pull down with 500 k Ω),		
					Device goes to standby mode. Supply current reduces to the least as I_std.		
2	GND	Power	Ground				
3	OUT	Output	Clock output				
4	V _{CC}	Power	Power supply				

*1 If fixing it at High, please connect to V_{CC} directly.

*2 If fixing it at Low, please connect to GND directly. *3 If necessary to use Open, please select Output Enable function.

Product Name



 e: Frequency tolerance / f: Operating temperature

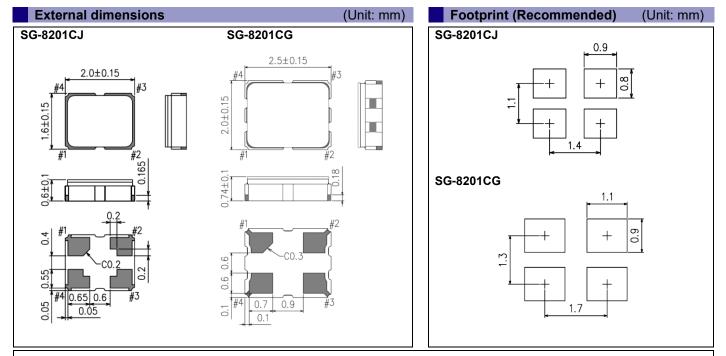
 BH
 ±15 × 10⁻⁶ / -40 °C to +105 °C

 DJ
 ±25 x 10⁻⁶ / -40 °C to +125 °C

e: Frequency tolerance f: Operating temperature

g: Function h: Rise/Fall time

g: Function			h: Rise/Fall time		
Ρ	Output Enable (OE)		Α	Default	
Q	Output Enable (OE)		В	Faster	
S	Standby (ST)		С	Fast	
Т	Standby (ST)		D	Slow	
			Е	Slower	



Notes:

In order to achieve optimum jitter performance, the 0.1 µF capacitor between V_{CC} and GND should be placed. It is also recommended that the capacitors are placed on the device side of the PCB, as close to the device as possible and connected together with short wiring pattern.

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